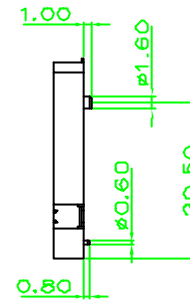
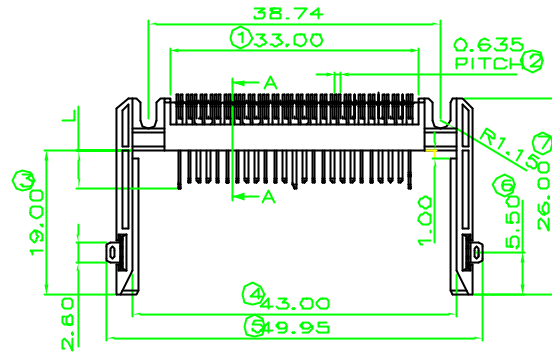


ENGINEERING DRAWING

REVISIONS

SYM	ECN NO.	DESCRIPTION	DATE	APPROVED
AX1			11/01/2001	AMY



1. MATERIAL/FINISH:
PLASTIC BODY : HIGHT TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOYS
MOUNT EAR : COPPER ALLOYS
CONTACT AREA :10u" GOLD
PLATING NI UNDER PLATING.
SOLDER TAIL AREA : TIN LEAD PLATING
MOUNT EAR : TIN PLATING NI UNDER PLATING.
2. SOLDER TAIL TO BE WITHIN 0.05 UPWARD AND
0.2 DOWNWARD FROM Z-DATUM PLACE, AND
COPLANALITY OF SOLDERTAILS TO BE WITHIN 0.12.
MEASUREMENT POINT IS SOLDERTAILS TIP.
3. PLEASE REFER TO TABLE 1 FOR TERMINAL LENGTH.
4. 外觀不可有毛邊變形、污損、水
5. 標有號碼者，為重點尺寸。
6. PART NO:
TCH050-X002

L-D-TYPE 1 NORMAL
1-TYPE 1 REVERSE

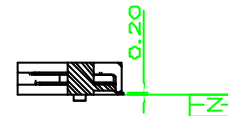
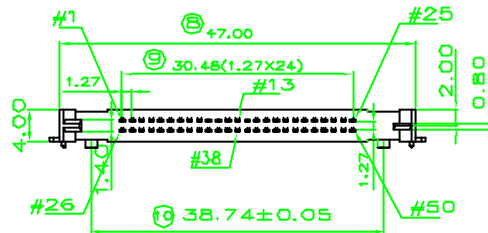
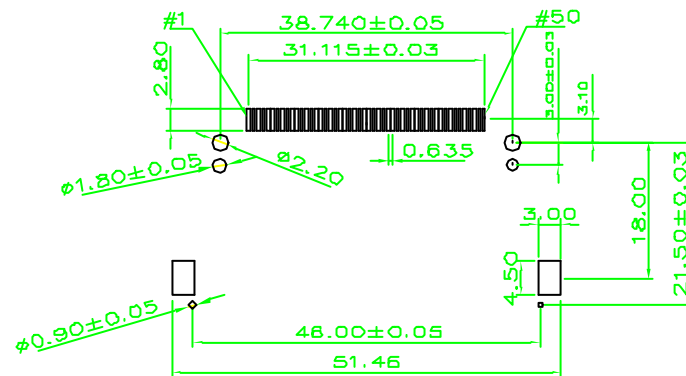
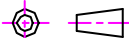


TABLE 1

PIN NUMBER	DIM.L± 0.10
25,26	3.50
ALL OTHER PINS	4.25
1,13,38,50	5.00



RECOMMENDED HOLE PATTERN

TOLERANCE					DR		TC&C ELECTRONIC CO.,LTD.		
SELECT					AMY				
IN./TOL.	1	2	3	CHKD			TITLE CF HEADER TYPE 1 CONNECTOR LOW PROFILE TYPE		
0.000 +/-	0.05	0.1	0.15	APPD					
0.00 +/-	0.1	0.15	0.25	UNIT					
0.0 +/-	0.15	0.3	0.5	SCALE					
0.1 +/-	0.25	0.5	1.0	MM					
ANGLE +/-				SHEET		REV		PART NO. TCH050-X002	DRAWING NO. TC05027X002
				1/1		AX1			